## PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Christopher James Healy	05/13/2009

### **RECEIVING PARTY DATA**

Name:	QUALCOMM Incorporated	
Street Address:	5775 Morehouse Drive	
Internal Address:	Patent Department	
City:	San Diego	
State/Country:	CALIFORNIA	
Postal Code:	92121-1714	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12482668

### **CORRESPONDENCE DATA**

Fax Number: (858)658-2502

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 858-658-5787

Email: us-docketing@qualcomm.com
Correspondent Name: QUALCOMM Incorporated
Address Line 1: 5775 Morehouse Drive
Address Line 2: Patent Department

Address Line 4: San Diego, CALIFORNIA 92121-1714

ATTORNEY DOCKET NUMBER: 082087

NAME OF SUBMITTER: Peter M. Kamarchik

**Total Attachments: 2** 

500883431

source=082087\_ASG\_06-11-2009#page1.tif source=082087\_ASG\_06-11-2009#page2.tif

PATENT

REEL: 022811 FRAME: 0984

**\$40.00** 124

PATENT Docket No.: 082087

Page 1 of 2

## ASSIGNMENT

TO WHOM IT MAY CONCERN:

For the sum of One Dollar and other valuable consideration to us in hand paid, receipt of which is hereby acknowledged, be it known that We/I,

Christopher James Healy, a citizen of the United States, having a mailing address of 5775 Morehouse Drive, San Diego, CA 92121; and a resident of San Diego, CA.

have sold, assigned and transferred and by these presents do sell, assign, transfer and set over unto QUALCOMM Incorporated, a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, its successors, legal representatives, or assigns, the entire right, title and interest in and to a certain invention relating to Method for Manufacturing Tight Pitch, Flip Chip Integrated Circuit Packages by me devised and the application for United States Patent therefore filed in the United States Patent and Trademark Office on Tune 11, 2009, and assigned Serial No. 12 (and I hereby authorize and instruct QUALCOMM Incorporated to hereafter complete this Assignment by inserting the serial number and date in the space provided above when known), and all original and reissue patents granted thereof, and all divisions, continuations and continuations-in-part thereof, including the subject matter of any and all claims which may be obtained in every such patent, and all foreign rights to said invention, and covenant that I have full right to do so, and agree that I will communicate to said corporation or its representatives all facts known to me respecting said invention, whenever requested, and testify in any legal proceedings, sign all lawful papers, make all rightful oaths and generally do everything possible to aid said corporation, its successors, assigns and nominees, to obtain and enforce proper patent protection for said invention in all countries.

**PATENT** 

REEL: 022811 FRAME: 0985

PATENT Docket No.: 082087 Page 2 of 2

# **ASSIGNMENT**

The Commissioner of Patents and Trademarks is requested to issue the Letters Patent which may be granted for said invention or any part thereof unto said corporation in keeping with this Assignment.

Done at San Diego, California this <u>13</u> day of <u>MAY</u>, 2009.

**RECORDED: 06/11/2009** 

Christopher James Healy

PATENT

REEL: 022811 FRAME: 0986